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March 2013

SuperFET II



FCH041N60F 600V N-Channel MOSFET, FRFET

Features

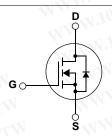
- R_{DS(on)}= 36mΩ (Typ)
- Ultra low gate charge (Typ. Q_g=277nC)
- · Low effective output capacitance
- 100% avalanche tested
- RoHS Compliant

Description

SuperFET[®]II is, Farichild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET[®]II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	TON.	Parameter		FCH041N60F	Units
V _{DSS}	Drain to Source Voltage	W 100 - COM		600	V
V WWW	Gate to Source Voltage	-DC	DC		· VI
V_{GSS}	Gate to Source voltage	-AC	(f>1Hz)	30	COAN
I _D	Drain Current	-Continuous (T _C = 25°C)	Mil	76	CAN
		-Continuous (T _C = 100°C)	WILL	48.1	, CA
I _{DM}	Drain Current	- Pulsed	(Note 1)	228	A
E _{AS}	Single Pulsed Avalanche Ene	ergy	(Note 2)	2025	mJ
I _{AR}	Avalanche Current	M MM 1005.	(Note 1)	15	A
E _{AR}	Repetitive Avalanche Energy	WWW.	(Note 1)	5.95	mJ
dv/dt	MOSFET dv/dt		COM	100	V/ns
av/ai	Peak Diode Recovery dv/dt	TW WWW.100	(Note 3)	50	V/IIS
D	Power Dissipation	$(T_C = 25^{\circ}C)$	COM	595	W
P_{D}		- Derate above 25°C	COM	4.76	W/°C
T _J , T _{STG}	Operating and Storage Temp	erature Range	007.	-55 to +150	°C
T _L	Maximum Lead Temperature 1/8" from Case for 5 Seconds		100Y.CO	300	°C

Thermal Characteristics

Symbol	Parameter	FCH041N60F	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.21	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	3C/VV

WWW.19

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH041N60F	FCH041N60F	TO-247	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	OWITE	30

Electrical Characteristics T_C = 25°C unless otherwise noted

Syllibol	Farantetei	lest conditions	- IVIIII.	Typ.	IVIAA.	Ullita
Off Charac	cteristics					
DV	Drain to Source Breakdown Voltage	$I_D = 10 \text{mA}, V_{GS} = 0 \text{V}, T_J = 25 ^{\circ} \text{C}$	600	-	-	V
BV _{DSS} Drain	Drain to Source Breakdown Voltage	$I_D = 10$ mA, $V_{GS} = 0$ V, $T_J = 150$ °C	650	W -	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 10mA, Referenced to 25°C	COM.	0.67	-	V/°C
COM.	Zero Gate Voltage Drain Current	$V_{DS} = 480V, V_{GS} = 0V$	COR	No.	1	^
I _{DSS}	Zero Gate voltage Drain Current	$V_{DS} = 480V, T_{C} = 125^{\circ}C$	01	1	10	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	N	W.T.N.	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	100	3	TI	5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 38A$	MIN	- V (36	41	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 20V, I_{D} = 38A$	(Note 4)	Δ×.	64.5		S

Dynamic Characteristics

C _{iss}	Input Capacitance	02-14-01/14-01/	N 100	10800	14365	pF
C _{oss}	Output Capacitance	$V_{DS} = 100V, V_{GS} = 0V$ f = 1MHz	44.	324	430	рF
C _{rss}	Reverse Transfer Capacitance	I = IIVIIZ		4.5	Mri	pF
C _{oss}	Output Capacitance	$V_{DS} = 380V, V_{GS} = 0V, f = 1.0MHz$	- N.1	185	014.1	pF
Coss eff.	Effective Output Capacitance	$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$	M.I.	748	- 11	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 380V, I _D = 38A	T T	277	360	nC
Q _{gs}	Gate to Source Gate Charge		- 13	65.3	Min	nC
Q _{gd}	Gate to Drain "Miller" Charge	V _{GS} = 10V (Note 4)		116		nC
ESR	Equivalent Series Resistance	f=1MHz	WW	1,00	1.00	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	MIN ON COM	- 1	63	136	ns
t _r	Turn-On Rise Time	$V_{DD} = 380V, I_{D} = 38A$	-	66	142	ns
t _{d(off)}	Turn-Off Delay Time	$R_{GEN} = 4.7\Omega$	-	244	498	ns
t _f	Turn-Off Fall Time	(Note	4) -	53	116	ns

Drain-Source Diode Characteristics

-	231	
	4	Α
- 7/7	1.2	V
190	W 34.	ns
1490	W.	nC
_		

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. $I_{AS} = 15A$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$
- 3. $I_{SD} \le 38 \text{A}$, di/dt $\le 200 \text{A}/\mu\text{s}$, $V_{DD} \le 380 \text{V}$, Starting $T_J = 25^{\circ}\text{C}$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

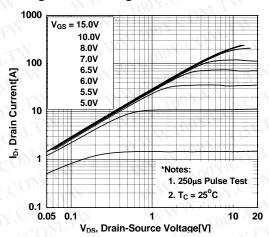


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

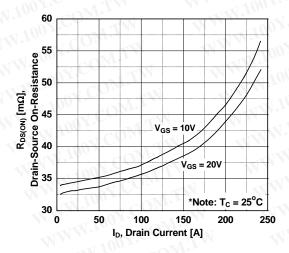


Figure 5. Capacitance Characteristics

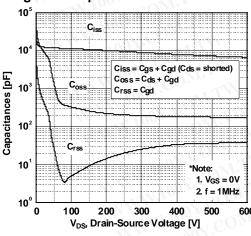


Figure 2. Transfer Characteristics

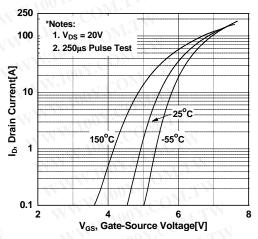


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

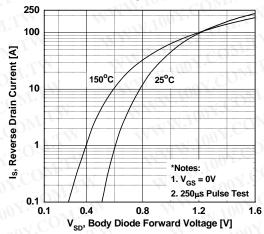
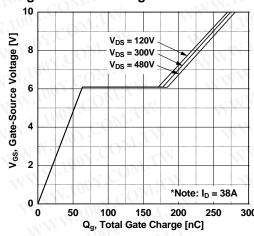


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

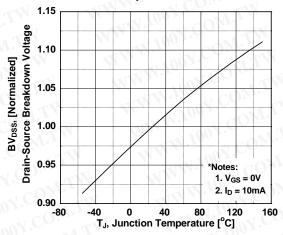


Figure 9. Maximum Safe Operating Area vs. Case Temperature

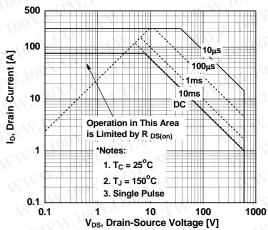


Figure 11. Eoss vs. Drain to Source Voltage

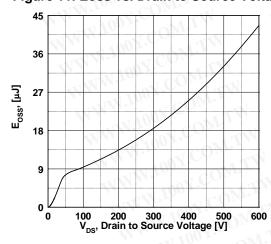


Figure 8. On-Resistance Variation vs. Temperature

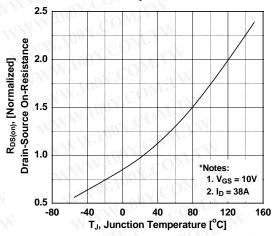
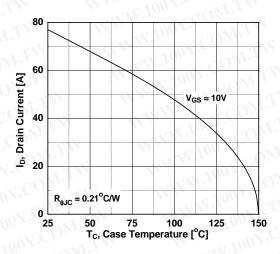


Figure 10. Maximum Drain Current



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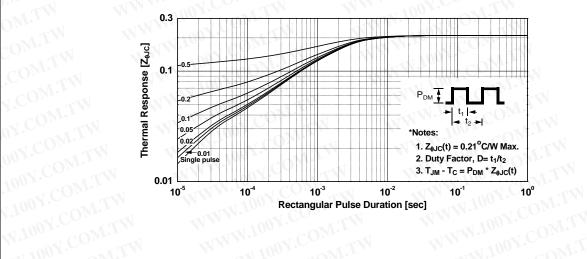
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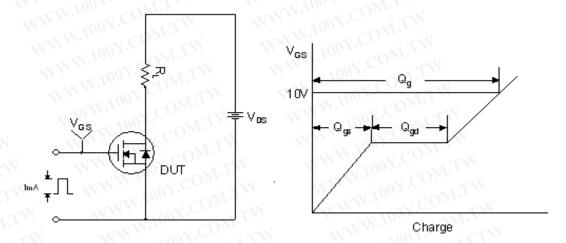
Typical Performance Characteristics (Continued)

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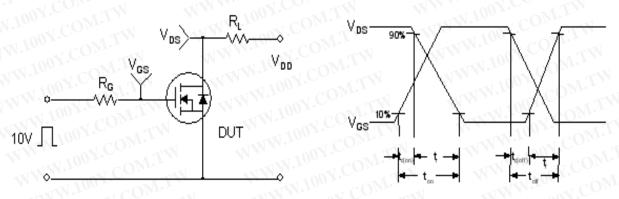




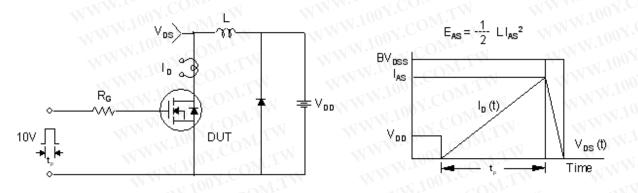
Gate Charge Test Circuit & Waveform



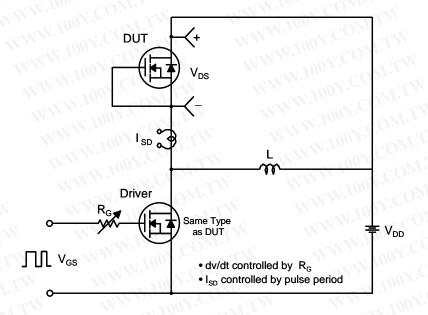
Resistive Switching Test Circuit & Waveforms

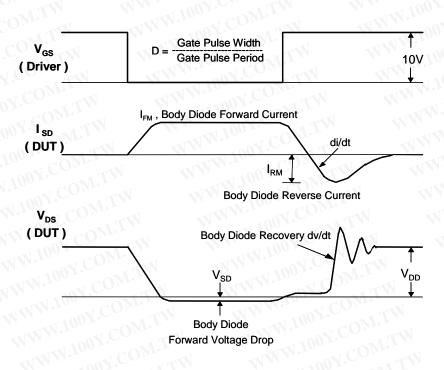


Unclamped Inductive Switching Test Circuit & Waveforms



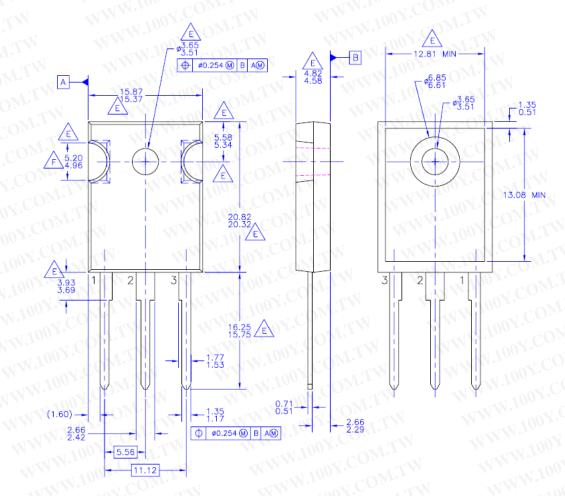
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

TO-247



NOTES: UNLESS OTHERWISE SPECIFIED

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